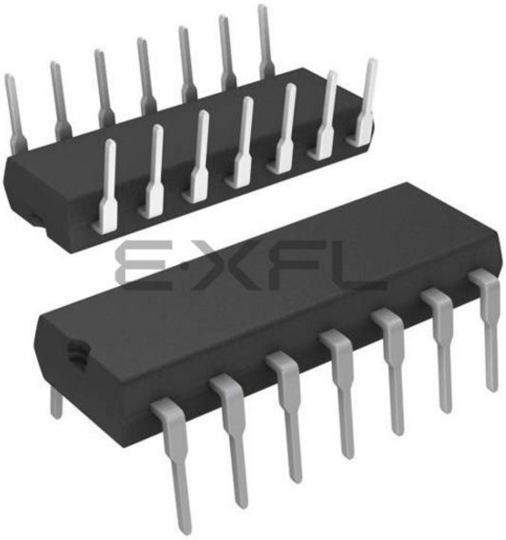


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	12
Program Memory Size	8KB (2.75K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 7x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	14-DIP (0.300", 7.62mm)
Supplier Device Package	14-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f08kl200-i-p

1.2 Other Special Features

- **Communications:** The PIC24F16KL402 family incorporates multiple serial communication peripherals to handle a range of application requirements. The MSSP module implements both SPI and I^{2}C™ protocols, and supports both Master and Slave modes of operation for each. Devices also include one of two UARTs with built-in IrDA® encoders/decoders.
- **Analog Features:** Select members of the PIC24F16KL402 family include a 10-bit A/D Converter module. The A/D module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period, as well as faster sampling speeds.
  The comparator modules are configurable for a wide range of operations and can be used as either a single or double comparator module.

1.3 Details on Individual Family Members

Devices in the PIC24F16KL402 family are available in 14-pin, 20-pin and 28-pin packages. The general block diagram for all devices is shown in Figure 1-1.

The PIC24F16KL402 family may be thought of as four different device groups, each offering a slightly different set of features. These differ from each other in multiple ways:

- The size of the Flash program memory
- The presence and size of data EEPROM
- The presence of an A/D Converter and the number of external analog channels available
- The number of analog comparators
- The number of general purpose timers
- The number and type of CCP modules (i.e., CCP vs. ECCP)
- The number of serial communications modules (both MSSPs and UARTs)

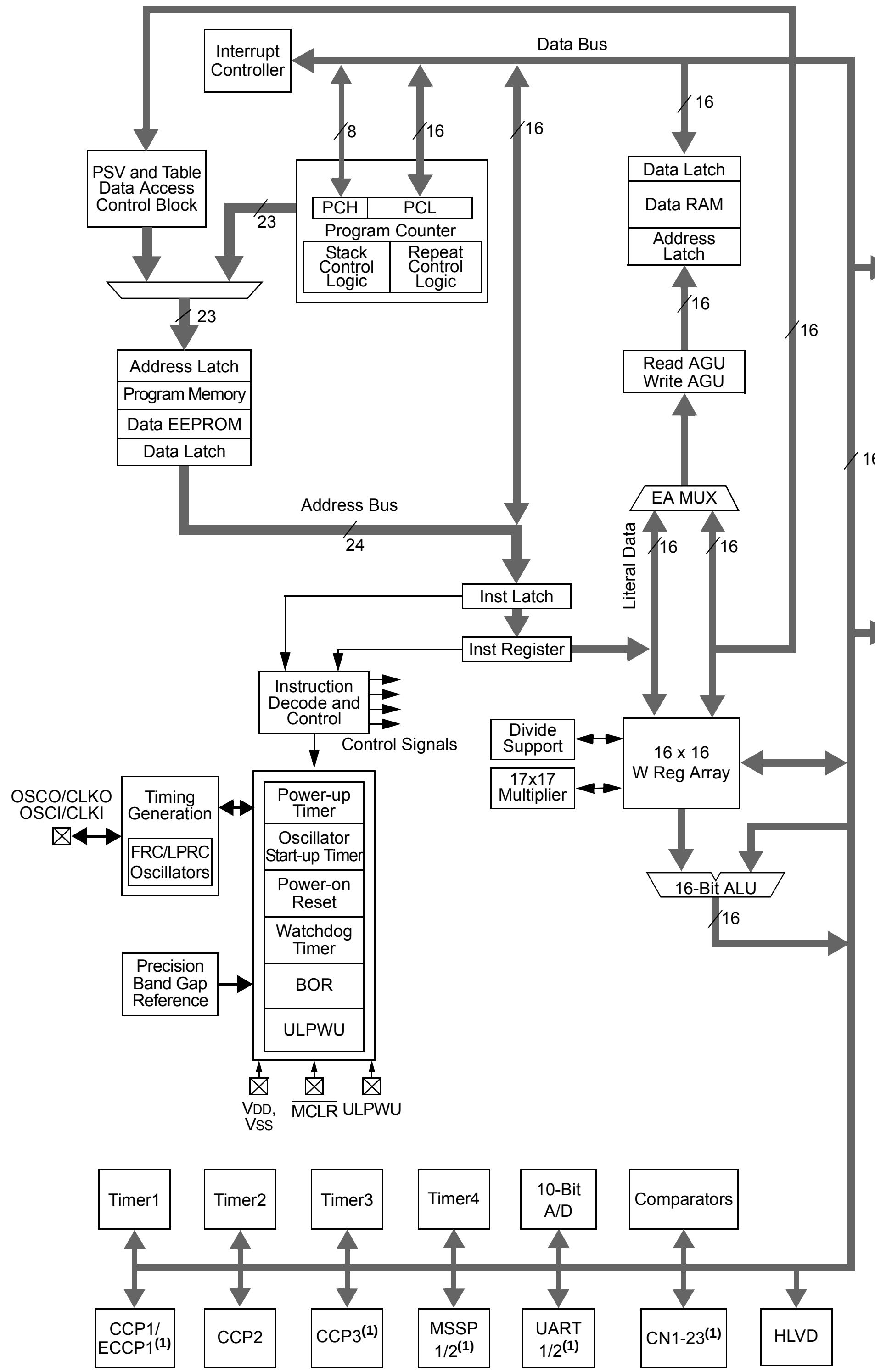
The general differences between the different sub-families are shown in Table 1-1. The feature sets for specific devices are summarized in Table 1-2 and Table 1-3.

A list of the individual pin features available on the PIC24F16KL402 family devices, sorted by function, is provided in Table 1-4 (for PIC24FXXKL40X/30X devices) and Table 1-5 (for PIC24FXXKL20X/10X devices). Note that these tables show the pin location of individual peripheral features and not how they are multiplexed on the same pin. This information is provided in the pinout diagrams in the beginning of this data sheet. Multiplexed features are sorted by the priority given to a feature, with the highest priority peripheral being listed first.

TABLE 1-1: FEATURE COMPARISON FOR PIC24F16KL402 FAMILY GROUPS

Device Group	Program Memory (bytes)	Data EEPROM (bytes)	Timers (8/16-bit)	CCP and ECCP	Serial (MSSP/ UART)	A/D (channels)	Comparators
PIC24FXXKL10X	4K	—	1/2	2/0	1/1	—	1
PIC24FXXKL20X	8K	—	1/2	2/0	1/1	7 or 12	1
PIC24FXXKL30X	8K	256	2/2	2/1	2/2	—	2
PIC24FXXKL40X	8K or 16K	512	2/2	2/1	2/2	12	2

FIGURE 1-1: PIC24F16KL402 FAMILY GENERAL BLOCK DIAGRAM



Note 1: All pins or features are not implemented on all device pinout configurations. See Table 1-4 and Table 1-5 for I/O port pin descriptions.

TABLE 1-4: PIC24F16KL40X/30X FAMILY PINOUT DESCRIPTIONS (CONTINUED)

Function	Pin Number				I/O	Buffer	Description
	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	28-Pin SPDIP/ SSOP/ SOIC	28-Pin QFN			
SOSCI	9	6	11	8	I	ANA	Secondary Oscillator Input
SOSCO	10	7	12	9	O	ANA	Secondary Oscillator Output
$\overline{SS1}$	12	9	26	23	O	—	SPI1 Slave Select
$\overline{SS2}$	15	12	23	20	O	—	SPI2 Slave Select
T1CK	13	10	18	15	I	ST	Timer1 Clock
T3CK	18	15	26	23	I	ST	Timer3 Clock
T3G	6	3	6	3	I	ST	Timer3 External Gate Input
U1CTS	12	9	17	14	I	ST	UART1 Clear-to-Send Input
U1RTS	13	10	18	15	O	—	UART1 Request-to-Send Output
U1RX	6	3	6	3	I	ST	UART1 Receive
U1TX	11	8	16	13	O	—	UART1 Transmit
U2CTS	10	7	12	9	I	ST	UART2 Clear-to-Send Input
U2RTS	9	6	11	8	O	—	UART2 Request-to-Send Output
U2RX	5	2	5	2	I	ST	UART2 Receive
U2TX	4	1	4	1	O	—	UART2 Transmit
ULPWU	4	1	4	1	I	ANA	Ultra Low-Power Wake-up Input
VDD	20	17	13, 28	10, 25	P	—	Positive Supply for Peripheral Digital Logic and I/O Pins
VREF+	2	19	2	27	I	ANA	A/D Reference Voltage Input (+)
VREF-	3	20	3	28	I	ANA	A/D Reference Voltage Input (-)
VSS	19	16	8, 27	5, 24	P	—	Ground Reference for Logic and I/O Pins

Legend: TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; I^2C = I^2C™/SMBus input buffer

TABLE 1-5: PIC24F16KL20X/10X FAMILY PINOUT DESCRIPTIONS (CONTINUED)

Function	Pin Number			I/O	Buffer	Description
	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	14-Pin PDIP/ TSSOP			
SCK1	15	12	8	I/O	ST	MSSP1 SPI Serial Input/Output Clock
SCL1	12	9	8	I/O	I^2C	MSSP1 I^2C Clock Input/Output
SCLKI	10	7	12	I	ST	Digital Secondary Clock Input
SDA1	13	10	9	I/O	I^2C	MSSP1 I^2C Data Input/Output
SDI1	17	14	11	I	ST	MSSP1 SPI Serial Data Input
SDO1	16	13	9	O	—	MSSP1 SPI Serial Data Output
SOSCI	9	6	11	I	ANA	Secondary Oscillator Input
SOSCO	10	7	12	O	ANA	Secondary Oscillator Output
$\overline{SS1}$	12	9	12	O	—	SPI1 Slave Select
T1CK	13	10	9	I	ST	Timer1 Clock
T3CK	18	15	12	I	ST	Timer3 Clock
T3G	6	3	11	I	ST	Timer3 External Gate Input
$\overline{U1CTS}$	12	9	8	I	ST	UART1 Clear-to-Send Input
$\overline{U1RTS}$	13	10	9	O	—	UART1 Request-to-Send Output
U1RX	6	3	12	I	ST	UART1 Receive
U1TX	11	8	11	O	—	UART1 Transmit
ULPWU	3	1	3	I	ANA	Ultra Low-Power Wake-up Input
VDD	20	17	14	P	—	Positive Supply for Peripheral Digital Logic and I/O Pins
VREF+	2	19	2	I	ANA	A/D Reference Voltage Input (+)
VREF-	3	20	3	I	ANA	A/D Reference Voltage Input (-)
VSS	19	16	13	P	—	Ground Reference for Logic and I/O Pins

Legend: TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; I^2C = I^2C™/SMBus input buffer

TABLE 4-8: MSSP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
SSP1BUF	0200	—	—	—	—	—	—	—	—	MSSP1 Receive Buffer/Transmit Register								00xx
SSP1CON1	0202	—	—	—	—	—	—	—	—	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000
SSP1CON2	0204	—	—	—	—	—	—	—	—	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000
SSP1CON3	0206	—	—	—	—	—	—	—	—	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000
SSP1STAT	0208	—	—	—	—	—	—	—	—	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000
SSP1ADD	020A	—	—	—	—	—	—	—	—	MSSP1 Address Register (I^{2}C™ Slave Mode) MSSP1 Baud Rate Reload Register (I^{2}C Master Mode)								0000
SSP1MSK	020C	—	—	—	—	—	—	—	—	MSSP1 Address Mask Register (I^{2}C Slave Mode)								00FF
SSP2BUF(1)	0210	—	—	—	—	—	—	—	—	MSSP2 Receive Buffer/Transmit Register								00xx
SSP2CON1(1)	0212	—	—	—	—	—	—	—	—	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000
SSP2CON2(1)	0214	—	—	—	—	—	—	—	—	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000
SSP2CON3(1)	0216	—	—	—	—	—	—	—	—	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000
SSP2STAT(1)	0218	—	—	—	—	—	—	—	—	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000
SSP2ADD(1)	021A	—	—	—	—	—	—	—	—	MSSP2 Address Register (I^{2}C Slave Mode) MSSP2 Baud Rate Reload Register (I^{2}C Master Mode)								0000
SSP2MSK(1)	021C	—	—	—	—	—	—	—	—	MSSP2 Address Mask Register (I^{2}C Slave Mode)								00FF

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-9: UART REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U1MODE	0220	UARTEN	—	USIDL	IREN	RTSMD	—	UEN1	UEN0	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U1STA	0222	UTXISEL1	UTXINV	UTXISEL0	—	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U1TXREG	0224	—	—	—	—	—	—	—	UART1 Transmit Register									xxxx
U1RXREG	0226	—	—	—	—	—	—	—	UART1 Receive Register									0000
U1BRG	0228	Baud Rate Generator Prescaler Register																0000
U2MODE	0230	UARTEN	—	USIDL	IREN	RTSMD	—	UEN1	UEN0	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U2STA	0232	UTXISEL1	UTXINV	UTXISEL0	—	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U2TXREG	0234	—	—	—	—	—	—	—	UART2 Transmit Register									xxxx
U2RXREG	0236	—	—	—	—	—	—	—	UART2 Receive Register									0000
U2BRG	0238	Baud Rate Generator Prescaler Register																0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-13: A/D REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ADC1BUF0	0300	A/D Buffer 0																xxxx
ADC1BUF1	0302	A/D Buffer 1																xxxx
AD1CON1	0320	ADON	—	ADSIDL	—	—	—	FORM1	FORM0	SSRC2	SSRC1	SSRC0	—	—	ASAM	SAMP	DONE	0000
AD1CON2	0322	VCFG2	VCFG1	VCFG0	OFFCAL	—	CSCNA	—	—	r	—	SMPI3	SMPI2	SMPI1	SMPI0	r	ALTS	0000
AD1CON3	0324	ADRC	EXTSAM	PUMPEN	SAMC4	SAMC3	SAMC2	SAMC1	SAMC0	—	—	ADCS5	ADCS4	ADCS3	ADCS2	ADCS1	ADCS0	0000
AD1CHS	0328	CH0NB	—	—	—	CH0SB3	CH0SB2	CH0SB1	CH0SB0	CH0NA	—	—	—	CH0SA3	CH0SA2	CH0SA1	CH0SA0	0000
AD1CSSL	0330	CSSL15	CSSL14	CSSL13	CSSL12(1)	CSSL11(1)	CSSL10	CSSL9	CSSL8	CSSL7	CSSL6	—	CSSL4(1)	CSSL3(1)	CSSL2(1)	CSSL1	CSSL0	0000

Legend: — = unimplemented, read as '0', r = reserved bit. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

TABLE 4-14: ANALOG SELECT REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ANCFG	04DE	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VBGEN	0000
ANSA	04E0	—	—	—	—	—	—	—	—	—	—	—	—	ANSA3	ANSA2	ANSA1	ANSA0	000F
ANSB	04E2	ANSB15	ANSB14	ANSB13	ANSB12(1)	—	—	—	—	—	—	—	ANSB4	ANSB3(2)	ANSB2(1)	ANSB1(1)	ANSB0(1)	F01F(3)

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

2: These bits are unimplemented in 14-pin and 20-pin devices; read as '0'

3: Reset value for 28-pin devices is shown.

TABLE 4-15: COMPARATOR REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CMSTAT	0630	CMIDL	—	—	—	—	—	C2EVT(1)	C1EVT	—	—	—	—	—	—	C2OUT	C1OUT	xxxx
CVRCON	0632	—	—	—	—	—	—	—	—	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	0000
CM1CON	0634	CON	COE	CPOL	CLPWR	—	—	CEVT	COUT	EVPOL1	EVPOL0	—	CREF	—	—	CCH1	CCH0	xxxx
CM2CON(1)	0636	CON	COE	CPOL	CLPWR	—	—	CEVT	COUT	EVPOL1	EVPOL0	—	CREF	—	—	CCH1	CCH0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented in PIC24FXXKL10X/20X devices; read as '0'.

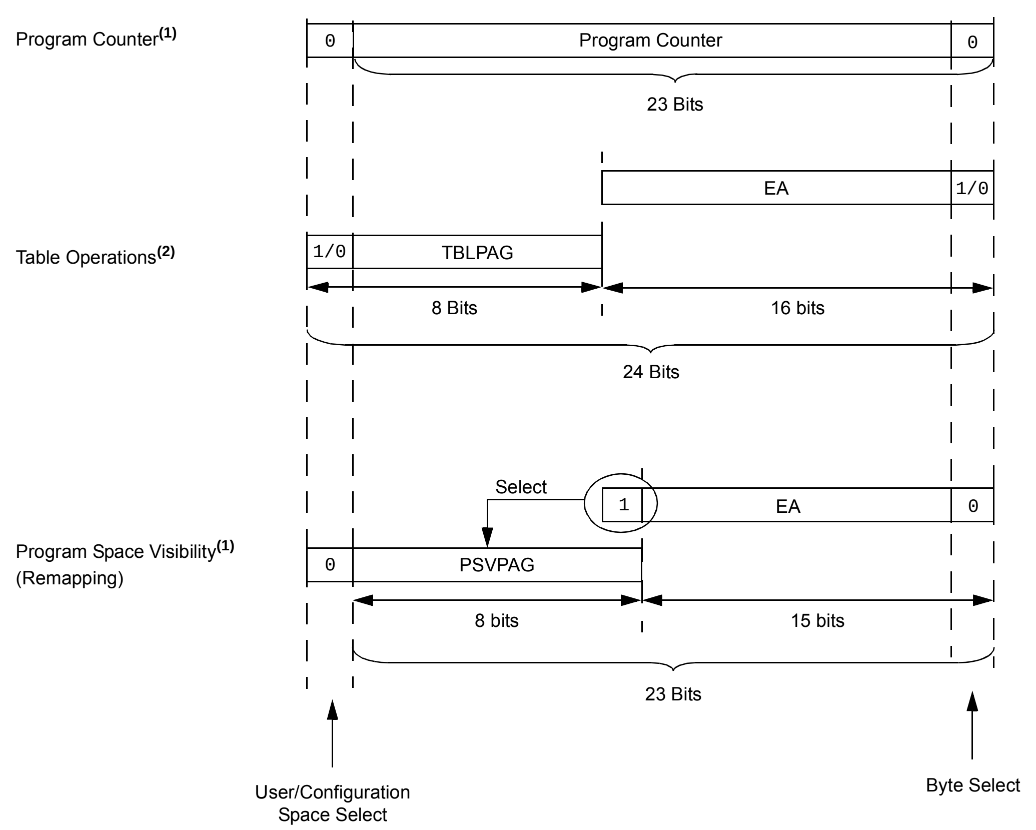
TABLE 4-20: PROGRAM SPACE ADDRESS CONSTRUCTION

Access Type	Access Space	Program Space Address				
		<23>	<22:16>	<15>	<14:1>	<0>
Instruction Access (Code Execution)	User	0	PC<22:1>			0
		0xx xxxx xxxx xxxx xxxx xxx0				
TBLRD/TBLWT (Byte/Word Read/Write)	User	TBLPAG<7:0>		Data EA<15:0>		
		0xxx xxxx		xxxx xxxx xxxx xxxx		
	Configuration	TBLPAG<7:0>		Data EA<15:0>		
		1xxx xxxx		xxxx xxxx xxxx xxxx		
Program Space Visibility (Block Remap/Read)	User	0	PSVPAG<7:0>(2)		Data EA<14:0>(1)	
		0	xxxx xxxx		xxx xxxx xxxx xxxx	

Note 1: Data EA<15> is always '1' in this case, but is not used in calculating the program space address. Bit 15 of the address is PSVPAG<0>.

2: PSVPAG can have only two values ('00' to access program memory and FF to access data EEPROM) on PIC24F16KL402 family devices.

FIGURE 4-5: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION



Note 1: The LSb of program space addresses is always fixed as '0' in order to maintain word alignment of data in the program and data spaces.

2: Table operations are not required to be word-aligned. Table read operations are permitted in the configuration memory space.

5.2 RTSP Operation

The PIC24F Flash program memory array is organized into rows of 32 instructions or 96 bytes. RTSP allows the user to erase blocks of 1 row, 2 rows and 4 rows (32, 64 and 128 instructions) at a time, and to program one row at a time.

The 1-row (96 bytes), 2-row (192 bytes) and 4-row (384 bytes) erase blocks and single row write block (96 bytes) are edge-aligned, from the beginning of program memory.

When data is written to program memory using `TBLWT` instructions, the data is not written directly to memory. Instead, data written using Table Writes is stored in holding latches until the programming sequence is executed.

Any number of `TBLWT` instructions can be executed and a write will be successfully performed. However, 32 `TBLWT` instructions are required to write the full row of memory.

The basic sequence for RTSP programming is to set up a Table Pointer, then do a series of `TBLWT` instructions to load the buffers. Programming is performed by setting the control bits in the NVMCON register.

Data can be loaded in any order and the holding registers can be written to multiple times before performing a write operation. Subsequent writes, however, will wipe out any previous writes.

Note:	Writing to a location multiple times without erasing it is not recommended.

All of the Table Write operations are single-word writes (two instruction cycles), because only the buffers are written. A programming cycle is required for programming each row.

5.3 Enhanced In-Circuit Serial Programming

Enhanced ICSP uses an on-board bootloader, known as the program executive, to manage the programming process. Using an SPI data frame format, the program executive can erase, program and verify program memory. For more information on Enhanced ICSP, see the device programming specification.

5.4 Control Registers

There are two SFRs used to read and write the program Flash memory: NVMCON and NVMKEY.

The NVMCON register (Register 5-1) controls the blocks that need to be erased, which memory type is to be programmed and when the programming cycle starts.

NVMKEY is a write-only register that is used for write protection. To start a programming or erase sequence, the user must consecutively write 55h and AAh to the NVMKEY register. For more information, refer to **Section 5.5 “Programming Operations”**.

5.5 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. During a programming or erase operation, the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

REGISTER 8-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
NVMIF	—	AD1IF	U1TXIF	U1RXIF	—	—	T3IF
bit 15							bit 8

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0
T2IF	CCP2IF	—	—	T1IF	CCP1IF	—	INT0IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **NVMIF:** NVM Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 14 **Unimplemented:** Read as ‘0’

bit 13 **AD1IF:** A/D Conversion Complete Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 12 **U1TXIF:** UART1 Transmitter Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 11 **U1RXIF:** UART1 Receiver Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 10-9 **Unimplemented:** Read as ‘0’

bit 8 **T3IF:** Timer3 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 7 **T2IF:** Timer2 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 6 **CCP2IF:** Capture/Compare/PWM2 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 5-4 **Unimplemented:** Read as ‘0’

bit 3 **T1IF:** Timer1 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 2 **CCP1IF:** Capture/Compare/PWM1 Interrupt Flag Status bit (ECCP1 on PIC24FXXKL40X devices)
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 1 **Unimplemented:** Read as ‘0’

bit 0 **INT0IF:** External Interrupt 0 Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

REGISTER 8-26: IPC12: INTERRUPT PRIORITY CONTROL REGISTER 12

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
—	—	—	—	—	BCL2IP2[(1)]	BCL2IP1[(1)]	BCL2IP0[(1)]
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	SSP2IP2[(1)]	SSP2IP1[(1)]	SSP2IP0[(1)]	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-11 **Unimplemented:** Read as ‘0’

bit 10-8 **BCL2IP<2:0>:** MSSP2 I^2C™ Bus Collision Interrupt Priority bits[(1)]

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **SSP2IP<2:0>:** MSSP2 SPI/I^2C Event Interrupt Priority bits[(1)]

111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-27: IPC16: INTERRUPT PRIORITY CONTROL REGISTER 16

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
—	—	—	—	—	U2ERIP2(1)	U2ERIP1(1)	U2ERIP0(1)
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	U1ERIP2(1)	U1ERIP1(1)	U1ERIP0(1)	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-11 **Unimplemented:** Read as ‘0’

bit 10-8 **U2ERIP<2:0>:** UART2 Error Interrupt Priority bits(1)
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **U1ERIP<2:0>:** UART1 Error Interrupt Priority bits(1)
111 = Interrupt is Priority 7 (highest priority interrupt)
•
•
•
001 = Interrupt is Priority 1
000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as ‘0’

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 16-1: CCPxCON: CCPx CONTROL REGISTER (STANDARD CCP MODULES)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DCxB1	DCxB0	CCPxM3(1)	CCPxM2(1)	CCPxM1(1)	CCPxM0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-6 **Unimplemented:** Read as ‘0’

bit 5-4 **DCxB<1:0>**: PWM Duty Cycle Bit 1 and Bit 0 for CCPx Module bits

Capture and Compare modes:
Unused.

PWM mode:
These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DCxB<9:2>) of the duty cycle are found in CCPRxL.

bit 3-0 **CCPxM<3:0>**: CCPx Module Mode Select bits(1)

1111 = Reserved
1110 = Reserved
1101 = Reserved
1100 = PWM mode
1011 = Compare mode: Special Event Trigger; resets timer on CCPx match (CCPxIF bit is set)
1010 = Compare mode: Generates software interrupt on compare match (CCPxIF bit is set, CCPx pin reflects I/O state)
1001 = Compare mode: Initializes CCPx pin high; on compare match, forces CCPx pin low (CCPxIF bit is set)
1000 = Compare mode: Initializes CCPx pin low; on compare match, forces CCPx pin high (CCPxIF bit is set)
0111 = Capture mode: Every 16th rising edge
0110 = Capture mode: Every 4th rising edge
0101 = Capture mode: Every rising edge
0100 = Capture mode: Every falling edge
0011 = Reserved
0010 = Compare mode: Toggles output on match (CCPxIF bit is set)
0001 = Reserved
0000 = Capture/Compare/PWM is disabled (resets CCPx module)

Note 1: CCPxM<3:0> = 1011 will only reset the timer and not start the A/D conversion on a CCPx match.

REGISTER 17-10: PADCFG1: PAD CONFIGURATION CONTROL REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	SDO2DIS[1]	SCK2DIS[1]	SDO1DIS	SCK1DIS
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-12 **Unimplemented:** Read as ‘0’

bit 11 **SDO2DIS:** MSSP2 SDO2 Pin Disable bit[1]
1 = The SPI output data (SDO2) of MSSP2 to the pin is disabled
0 = The SPI output data (SDO2) of MSSP2 is output to the pin

bit 10 **SCK2DIS:** MSSP2 SCK2 Pin Disable bit[1]
1 = The SPI clock (SCK2) of MSSP2 to the pin is disabled
0 = The SPI clock (SCK2) of MSSP2 is output to the pin

bit 9 **SDO1DIS:** MSSP1 SDO1 Pin Disable bit
1 = The SPI output data (SDO1) of MSSP1 to the pin is disabled
0 = The SPI output data (SDO1) of MSSP1 is output to the pin

bit 8 **SCK1DIS:** MSSP1 SCK1 Pin Disable bit
1 = The SPI clock (SCK1) of MSSP1 to the pin is disabled
0 = The SPI clock (SCK1) of MSSP1 is output to the pin

bit 7-0 **Unimplemented:** Read as ‘0’

Note 1: These bits are implemented only on PIC24FXXKL40X/30X devices.

24.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16 and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

24.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

24.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

24.5 MPLAB Assembler, Linker and Librarian for Various Device Families

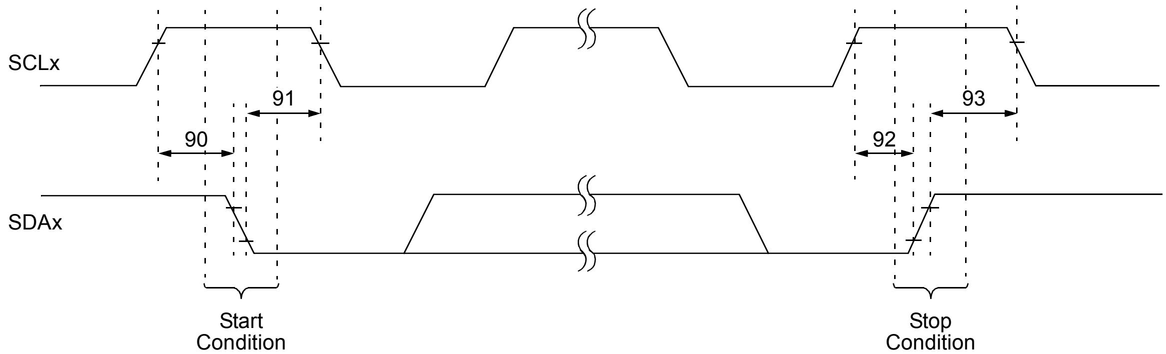
MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

TABLE 25-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
GOTO	GOTO Expr	Go to Address	2	2	None
	GOTO Wn	Go to Indirect	1	2	None
INC	INC f	f = f + 1	1	1	C, DC, N, OV, Z
	INC f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	INC Ws,Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
INC2	INC2 f	f = f + 2	1	1	C, DC, N, OV, Z
	INC2 f,WREG	WREG = f + 2	1	1	C, DC, N, OV, Z
	INC2 Ws,Wd	Wd = Ws + 2	1	1	C, DC, N, OV, Z
IOR	IOR f	f = f .IOR. WREG	1	1	N, Z
	IOR f,WREG	WREG = f .IOR. WREG	1	1	N, Z
	IOR #lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N, Z
	IOR Wb,Ws,Wd	Wd = Wb .IOR. Ws	1	1	N, Z
	IOR Wb,#lit5,Wd	Wd = Wb .IOR. lit5	1	1	N, Z
LNK	LNK #lit14	Link Frame Pointer	1	1	None
LSR	LSR f	f = Logical Right Shift f	1	1	C, N, OV, Z
	LSR f,WREG	WREG = Logical Right Shift f	1	1	C, N, OV, Z
	LSR Ws,Wd	Wd = Logical Right Shift Ws	1	1	C, N, OV, Z
	LSR Wb,Wns,Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N, Z
	LSR Wb,#lit5,Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N, Z
MOV	MOV f,Wn	Move f to Wn	1	1	None
	MOV [Wns+Slit10],Wnd	Move [Wns+Slit10] to Wnd	1	1	None
	MOV f	Move f to f	1	1	N, Z
	MOV f,WREG	Move f to WREG	1	1	None
	MOV #lit16,Wn	Move 16-bit Literal to Wn	1	1	None
	MOV.b #lit8,Wn	Move 8-bit Literal to Wn	1	1	None
	MOV Wn,f	Move Wn to f	1	1	None
	MOV Wns,[Wns+Slit10]	Move Wns to [Wns+Slit10]	1	1	None
	MOV Wso,Wdo	Move Ws to Wd	1	1	None
	MOV WREG,f	Move WREG to f	1	1	None
	MOV.D Wns,Wd	Move Double from W(ns):W(ns+1) to Wd	1	2	None
	MOV.D Ws,Wnd	Move Double from Ws to W(nd+1):W(nd)	1	2	None
MUL	MUL.SS Wb,Ws,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Signed(Ws)	1	1	None
	MUL.SU Wb,Ws,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(Ws)	1	1	None
	MUL.US Wb,Ws,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Signed(Ws)	1	1	None
	MUL.UU Wb,Ws,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(Ws)	1	1	None
	MUL.SU Wb,#lit5,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(lit5)	1	1	None
	MUL.UU Wb,#lit5,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(lit5)	1	1	None
	MUL f	W3:W2 = f * WREG	1	1	None
NEG	NEG f	f = $\overline{f}$ + 1	1	1	C, DC, N, OV, Z
	NEG f,WREG	WREG = $\overline{f}$ + 1	1	1	C, DC, N, OV, Z
	NEG Ws,Wd	Wd = $\overline{Ws}$ + 1	1	1	C, DC, N, OV, Z
NOP	NOP	No Operation	1	1	None
	NOPR	No Operation	1	1	None
POP	POP f	Pop f from Top-of-Stack (TOS)	1	1	None
	POP Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
	POP.D Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd+1)	1	2	None
	POP.S	Pop Shadow Registers	1	1	All
PUSH	PUSH f	Push f to Top-of-Stack (TOS)	1	1	None
	PUSH Wso	Push Wso to Top-of-Stack (TOS)	1	1	None
	PUSH.D Wns	Push W(ns):W(ns+1) to Top-of-Stack (TOS)	1	2	None
	PUSH.S	Push Shadow Registers	1	1	None

FIGURE 26-13: MSSPx I²C™ BUS START/STOP BITS TIMING WAVEFORMS

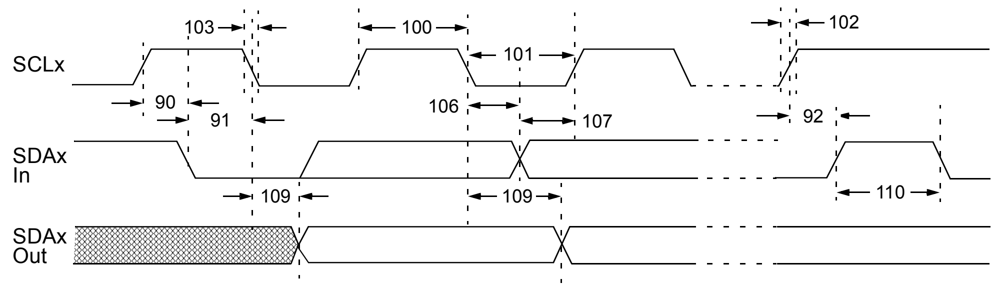


Note: Refer to Figure 26-3 for load conditions.

TABLE 26-33: I²C™ BUS START/STOP BITS REQUIREMENTS (MASTER MODE)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	Start Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	2(TOSC)(BRG + 1)	—		
91	THD:STA	Start Condition Hold Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	2(TOSC)(BRG + 1)	—		
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	
			400 kHz mode	2(TOSC)(BRG + 1)	—		
93	THD:STO	Stop Condition Hold Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ns	
			400 kHz mode	2(TOSC)(BRG + 1)	—		

FIGURE 26-14: MSSPx I²C™ BUS DATA TIMING



Note: Refer to Figure 26-3 for load conditions.

TABLE 26-34: I²C™ BUS DATA REQUIREMENTS (MASTER MODE)

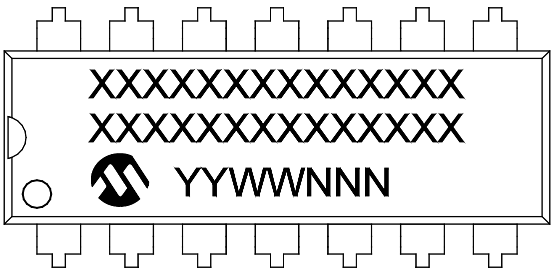
Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100	T_{HIGH}	Clock High Time	100 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
			400 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
101	T_{LOW}	Clock Low Time	100 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
			400 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
102	T_R	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	C_B is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 C_B	300	ns	
103	T_F	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	C_B is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 C_B	300	ns	
90	$T_{SU:STA}$	Start Condition Setup Time	100 kHz mode	2(T_{OSC})(BRG + 1)	—	—	Only relevant for Repeated Start condition
			400 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
91	$T_{HD:STA}$	Start Condition Hold Time	100 kHz mode	2(T_{OSC})(BRG + 1)	—	—	After this period, the first clock pulse is generated
			400 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
106	$T_{HD:DAT}$	Data Input Hold Time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
107	$T_{SU:DAT}$	Data Input Setup Time	100 kHz mode	250	—	ns	**(Note 1)**
			400 kHz mode	100	—	ns	
92	$T_{SU:STO}$	Stop Condition Setup Time	100 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
			400 kHz mode	2(T_{OSC})(BRG + 1)	—	—	
109	T_{AA}	Output Valid from Clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
110	T_{BUF}	Bus Free Time	100 kHz mode	4.7	—	μs	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	μs	
D102	C_B	Bus Capacitive Loading		—	400	pF	

Note 1: A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but Parameter 107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, Parameter 102 + Parameter 107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.

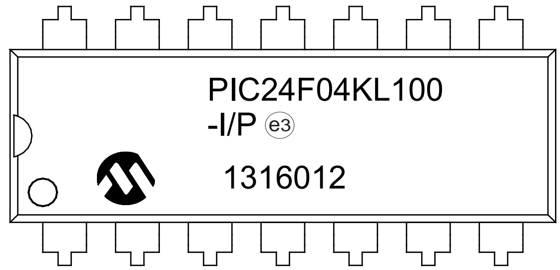
27.0 PACKAGING INFORMATION

27.1 Package Marking Information

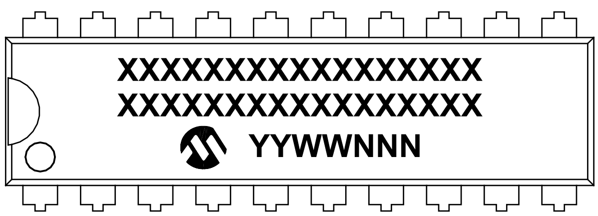
14-Lead PDIP (300 mil)



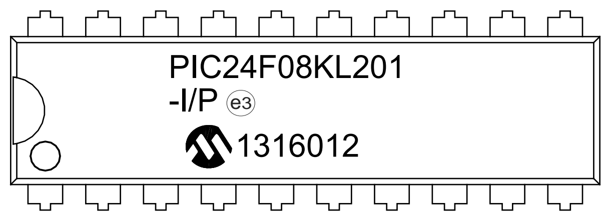
Example



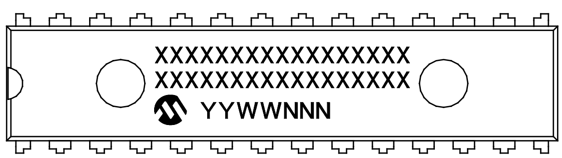
20-Lead PDIP (300 mil)



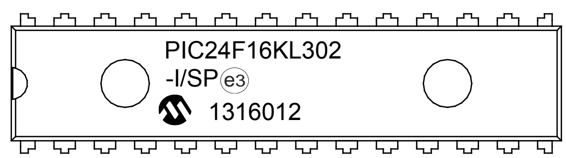
Example



28-Lead SPDIP (.300”)



Example

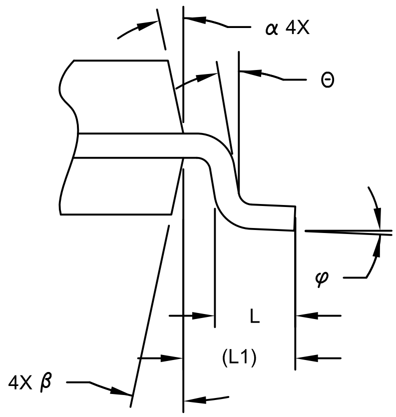


Legend:	XX...X	Product-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	e3	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

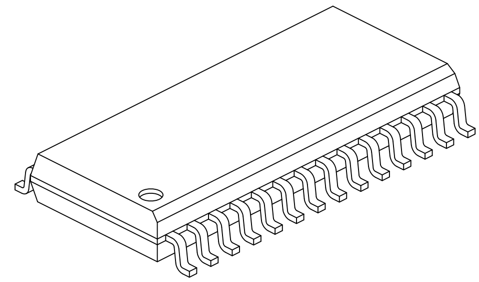
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



VIEW C



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		1.27 BSC	
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E		10.30 BSC	
Molded Package Width	E1		7.50 BSC	
Overall Length	D		17.90 BSC	
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1		1.40 REF	
Lead Angle	Θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

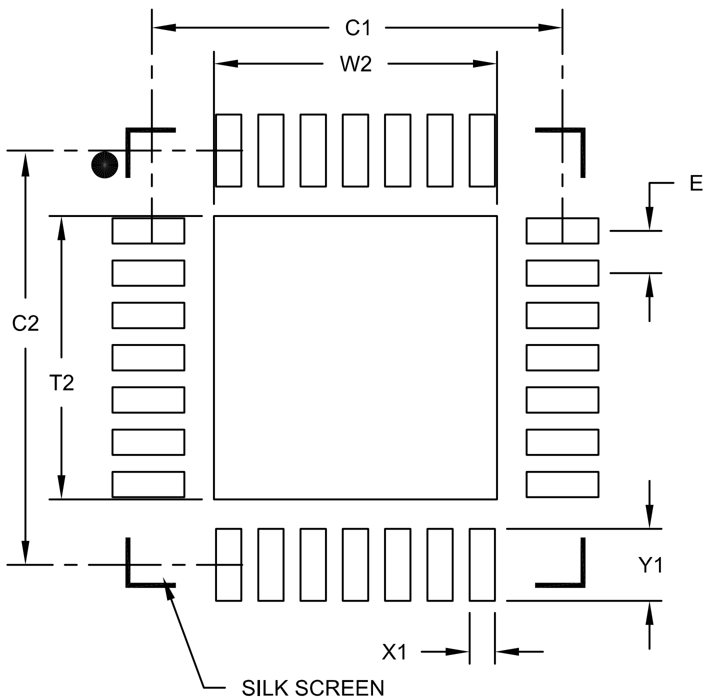
Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2

28-Lead Plastic Quad Flat, No Lead Package (MQ) – 5x5 mm Body [QFN] Land Pattern With 0.55 mm Contact Length

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Optional Center Pad Width	W2			3.35
Optional Center Pad Length	T2			3.35
Contact Pad Spacing	C1		4.90	
Contact Pad Spacing	C2		4.90	
Contact Pad Width (X28)	X1			0.30
Contact Pad Length (X28)	Y1			0.85

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2140A